

Application No.: 09/901,143
Inventor: Jie LIU et al.
For: MOLDING APPARATUS

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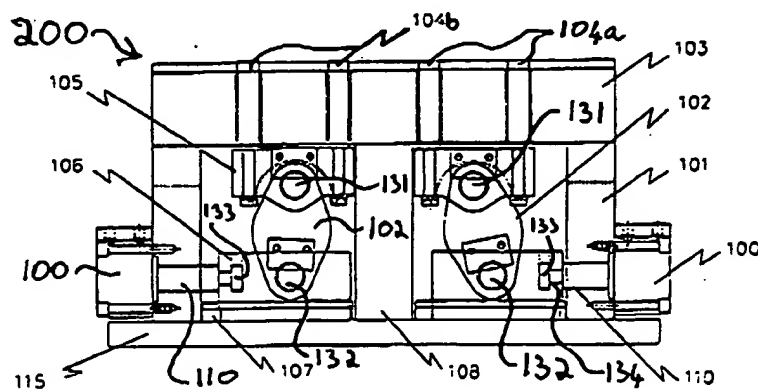


Figure 1

